Thyristors

BT300S series

Product specification

BT300M series

GENERAL DESCRIPTION

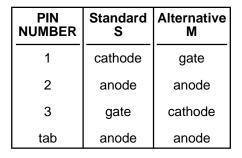
QUICK REFERENCE DATA

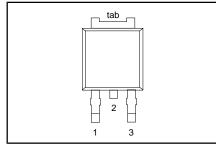
Glass passivated thyristors in a plastic envelope, suitable surface for mounting, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

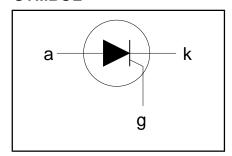
| SYMBOL | PARAMETER | MAX. | MAX. | MAX. | UNIT |
|---|---|-----------------------------|-----------------------------|-----------------------------|------------------|
| V _{DRM} , V _{RRM} I _{T(AV)} I _{T(RMS)} I _{TSM} | BT300S (or BT300M)- Repetitive peak off-state voltages Average on-state current RMS on-state current Non-repetitive peak on-state current | 500R 500 5 8 65 | 600R 600 5 8 65 | 800R 800 5 8 65 | V A A A |

PINNING - SOT428

SYMBOL







LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | | UNIT | |
|---|---|--|---------------|-------------------------------|-------------------------------|---------------------|------------------|
| V_{DRM} , V_{RRM} | Repetitive peak off-state voltages | | - | -500R 500 ¹ | -600R 600 ¹ | -800R 800 | > |
| I _{T(AV)} I _{T(RMS)} I _{TSM} | Average on-state current RMS on-state current Non-repetitive peak on-state current | half sine wave; $T_{mb} \le 107$ °C all conduction angles half sine wave; $T_j = 25$ °C prior to surge | - | | 5 8 | | A A |
| | | t = 10 ms t = 8.3 ms | - - | | 65 71 | | A A |
| l²t dl _⊤ /dt | I ² t for fusing Repetitive rate of rise of on-state current after triggering | t = 10 ms $I_{TM} = 10 \text{ A}; I_{G} = 50 \text{ mA};$ $dI_{G}/dt = 50 \text{ mA/}\mu\text{s}$ | - | | 21 50 | | A²s A/μs |
| I _{GM} V _{GM} V _{RGM} | Peak gate current Peak gate voltage Peak reverse gate voltage Peak gate power | | - - - | | 2 5 5 5 | | A V V W |
| P _{GM} P _{G(AV)} T _{stg} T _j | Average gate power Storage temperature Operating junction temperature | over any 20 ms period | - -40 - | | 0.5 150 125 | | \$ \$,00 |

September 1997 1 Rev 1.100

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 $A/\mu s$.

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THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------------|--|---|------|------|------|------|
| | Thermal resistance | | - | - | 2.2 | K/W |
| R _{th i-a} | junction to mounting base Thermal resistance junction to ambient | pcb (FR4) mounted; footprint as in Fig.14 | - | 75 | - | K/W |

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------------|---------------------------|---|------|------|------|------|
| I _{GT} | Gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$ | - | 2 | 15 | mA |
| l I | Latching current | $V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$ | - | 10 | 40 | mΑ |
| I _H | Holding current | $V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$ | - | 10 | 20 | mΑ |
| Ϊ́Τ | On-state voltage | $I_{T} = 12 \text{ A}$ | - | 1.35 | 1.6 | V |
| V _{GT} | Gate trigger voltage | $\dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$ | - | 0.6 | 1.5 | V |
| | | $V_{\rm D} = V_{\rm DRM(max)}$; $I_{\rm T} = 0.1 \text{ A}$; $T_{\rm i} = 125 ^{\circ}\text{C}$ | 0.25 | 0.4 | - | V |
| I_D, I_R | Off-state leakage current | $V_D = V_{DRM(max)}$; $V_R = V_{RRM(max)}$; $T_j = 125$ °C | - | 0.1 | 0.5 | mA |

DYNAMIC CHARACTERISTICS

 $T_j = 25$ °C unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------------|--|---|------|------|------|------|
| dV _D /dt | Critical rate of rise of off-state voltage | $V_{DM} = 67\% V_{DRM(max)}$; $T_j = 125 ^{\circ}C$; exponential waveform. | | | | |
| | | Gate open circuit | 50 | 100 | - | V/μs |
| | | $R_{GK} = 100 \Omega$ | 200 | 1000 | - | V/μs |
| t _{gt} | Gate controlled turn-on time | $I_{TM} = 10 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu \text{s}$ | - | 2 | - | μs |
| t _q | Circuit commutated turn-off time | $V_D = 67\% \ V_{DRM(max)}; \ T_j = 125 \ ^{\circ}C; \ I_{TM} = 12 \ A; \ V_R = 25 \ V; \ dI_{TM}/dt = 30 \ A/\mu s; \ dV_D/dt = 50 \ V/\mu s; \ R_{GK} = 100 \ \Omega$ | 1 | 70 | - | μs |

Philips Semiconductors Product specification

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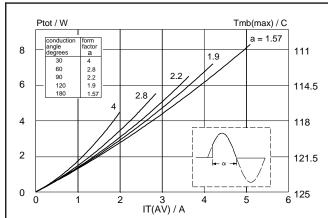


Fig.1. Maximum on-state dissipation, P_{tot} , versus average on-state current, $I_{T(AV)}$, where $a = form \ factor = I_{T(RMS)}/I_{T(AV)}$.

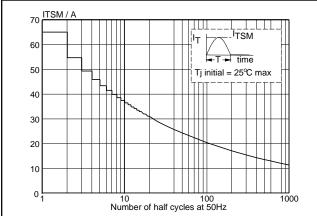


Fig.4. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

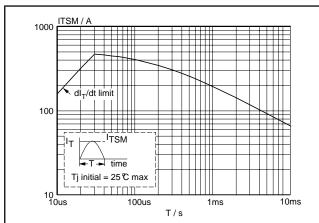


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \le 10$ ms.

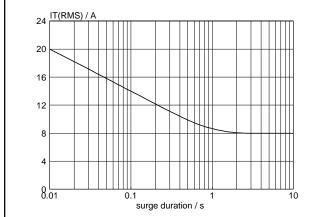


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{mb} \le 107$ °C.

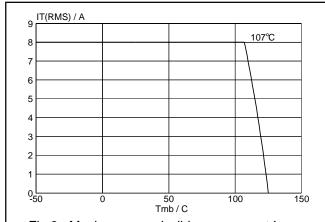
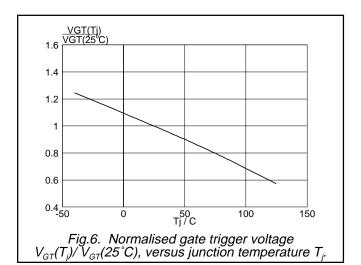
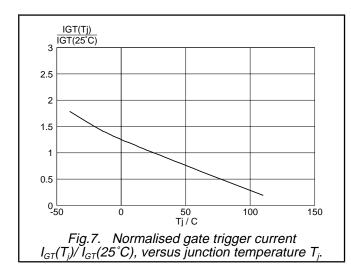


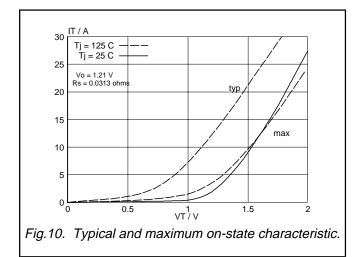
Fig.3. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

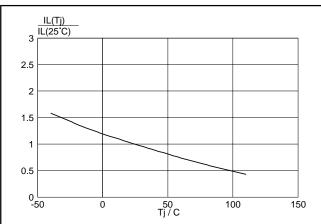


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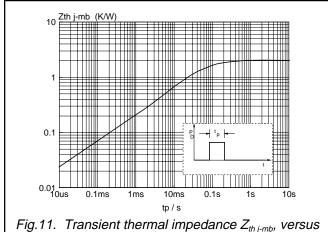
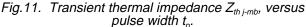
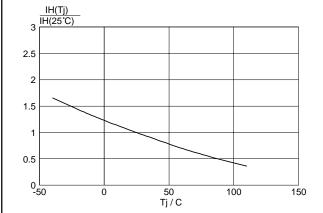


Fig.8. Normalised latching current $I_L(T_j)/I_L(25^{\circ}C)$, versus junction temperature T_j .





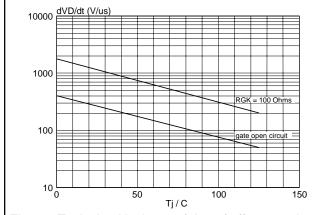
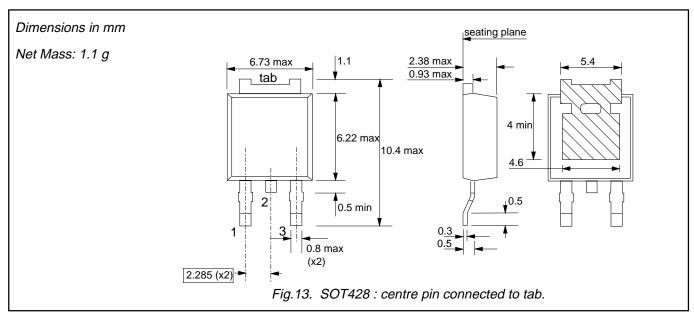


Fig.9. Normalised holding current $I_H(T_i)/I_H(25^{\circ}C)$, versus junction temperature T_j .

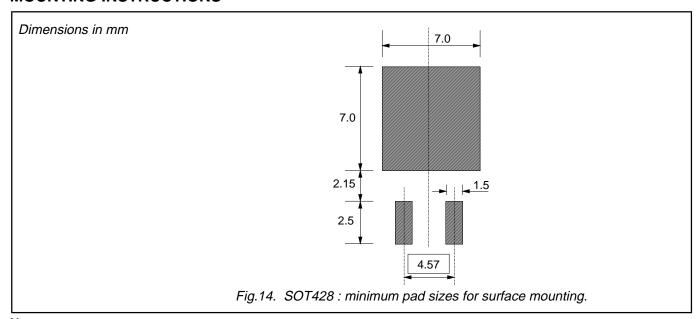
Fig.12. Typical, critical rate of rise of off-state voltage, dV_D/dt versus junction temperature T_j.

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MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

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DEFINITIONS

| Data sheet status | | | | | |
|--|---|--|--|--|--|
| Objective specification | This data sheet contains target or goal specifications for product development. | | | | |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. | | | | |
| Product specification This data sheet contains final product specifications. | | | | | |
| | | | | | |

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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